

How to Design a NFC Reader Application

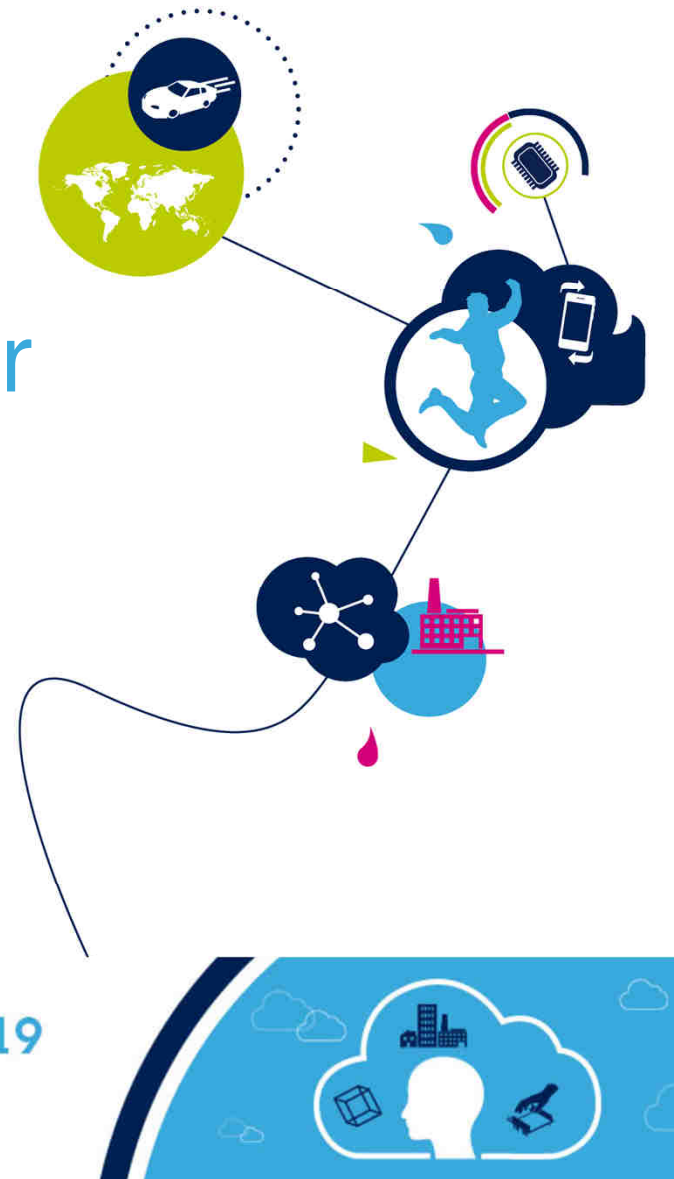
A Step by Step Approach

Daniel Merino



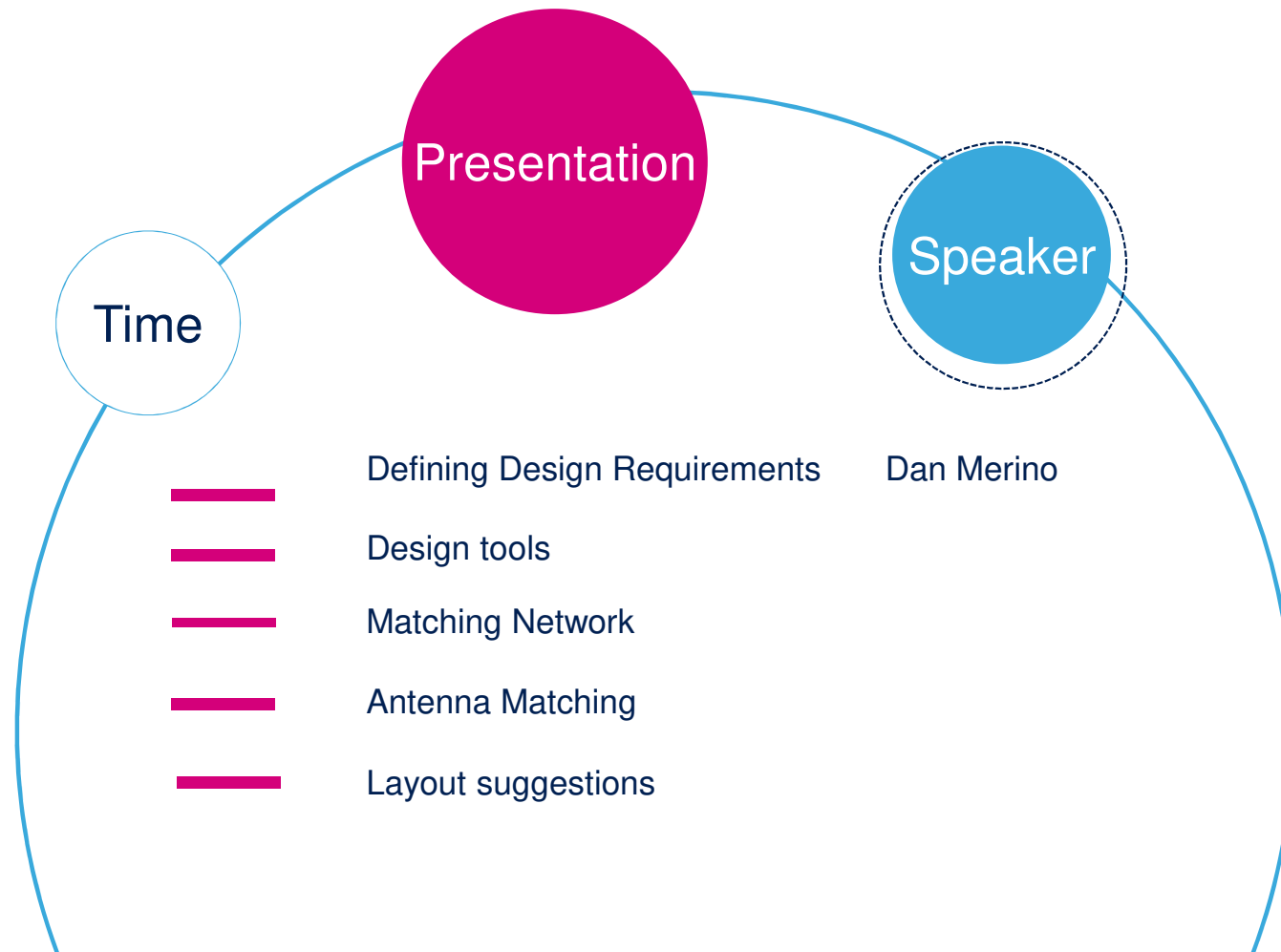
Technology Tour 2019

Minneapolis, MN | October 24



Agenda

2





Defining Design Requirements

Defining Design Requirements

4

- End Product
 - Payment
 - General Purpose
- Communication Protocol
 - ISO 14443 A/B
 - ISO 15693
 - Felica
 - AP2P.

Defining Design Requirements

5

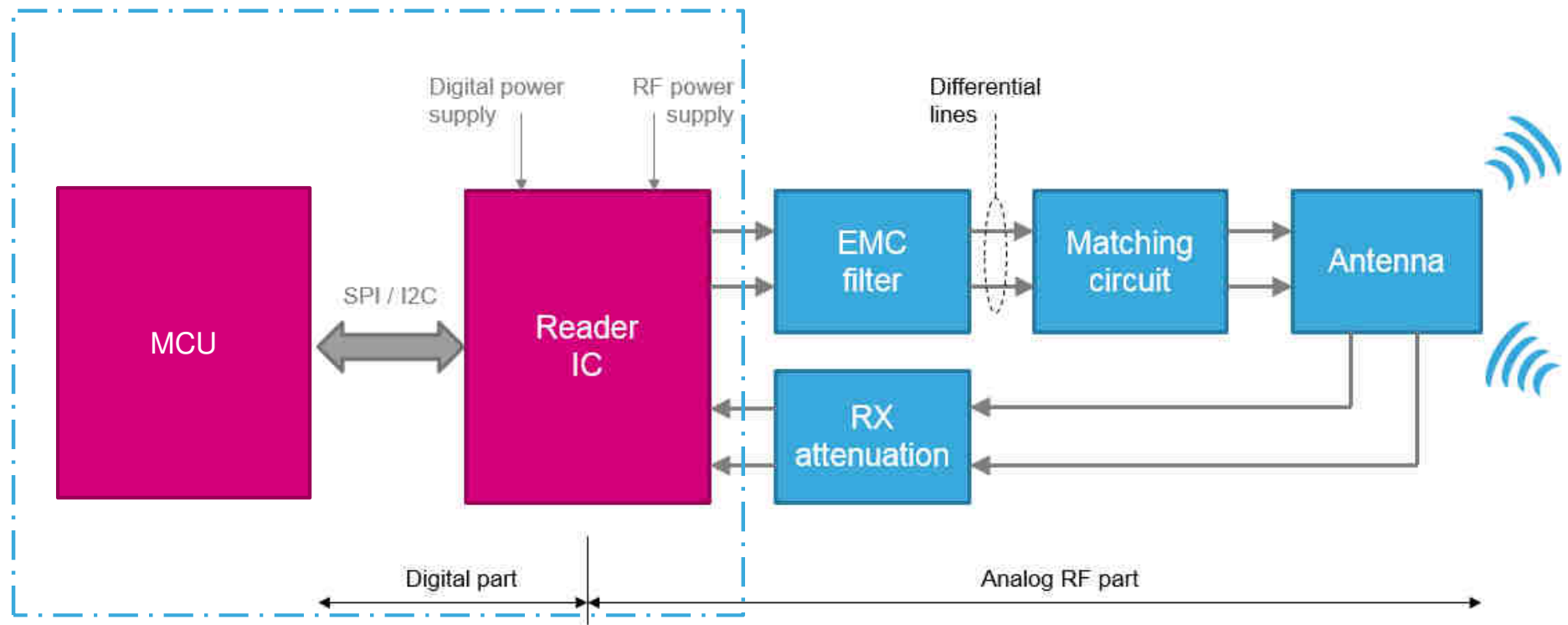
- System constraints
 - Antenna Size
 - Environmental Conditions
 - Metal
 - LCD screen
 - Antenna placement
- Design Trade-offs
 - Antenna size
 - Read Range
 - Current Consumption



System Block Diagram

System Block Diagram

7



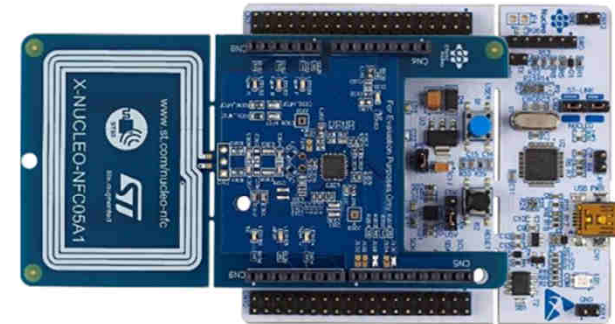


Design Tools

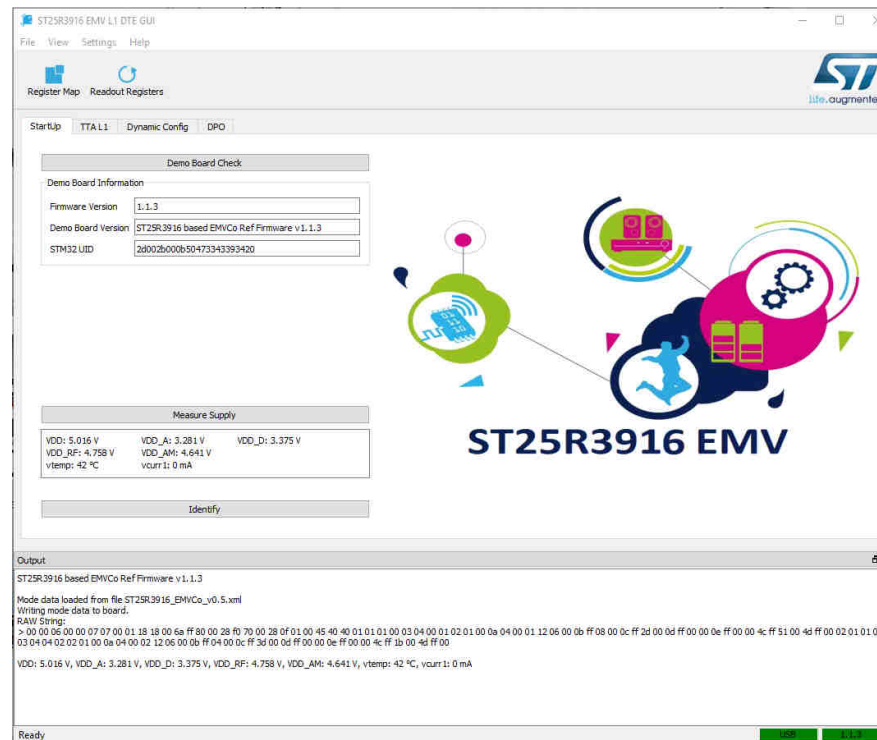
Design Tools

9

- ST25R3911B Discovery
 - Software GUI
 - Source code downloadable
 - Design files downloadable
- ST25R3911B Nucleo Shield
 - Firmware available
 - Design files downloadable
- ST25R3916 Discovery
 - Software GUI
 - Source code downloadable
 - Design files downloadable

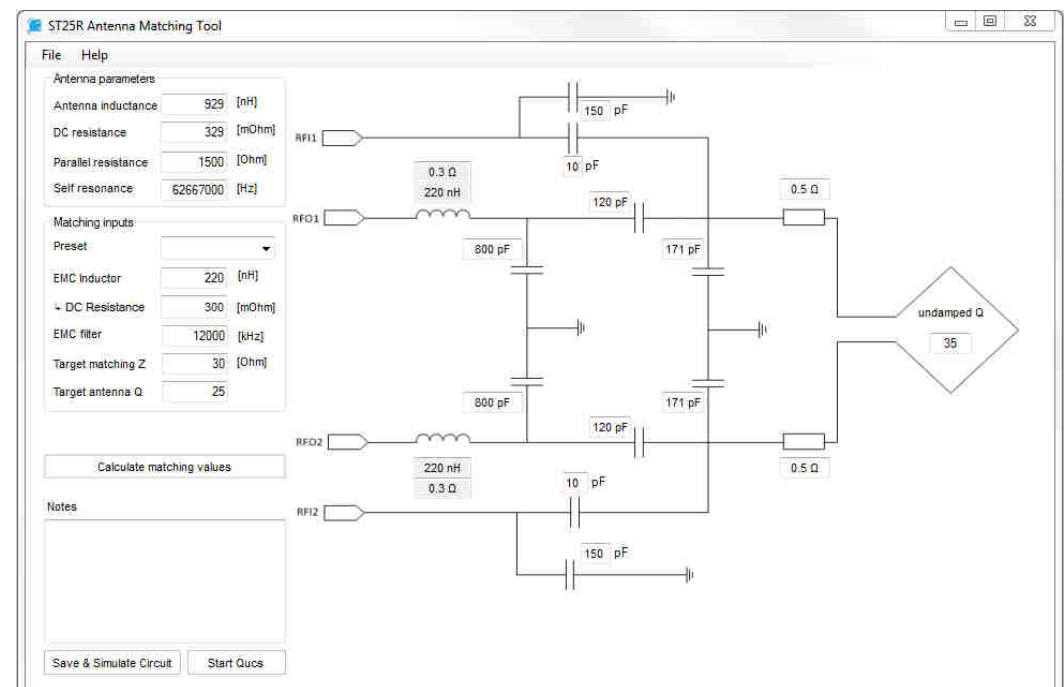


- EMVCo Reference design
 - Hardware eval board
 - Software GUI
 - L1 Stack
 - Available only by Request



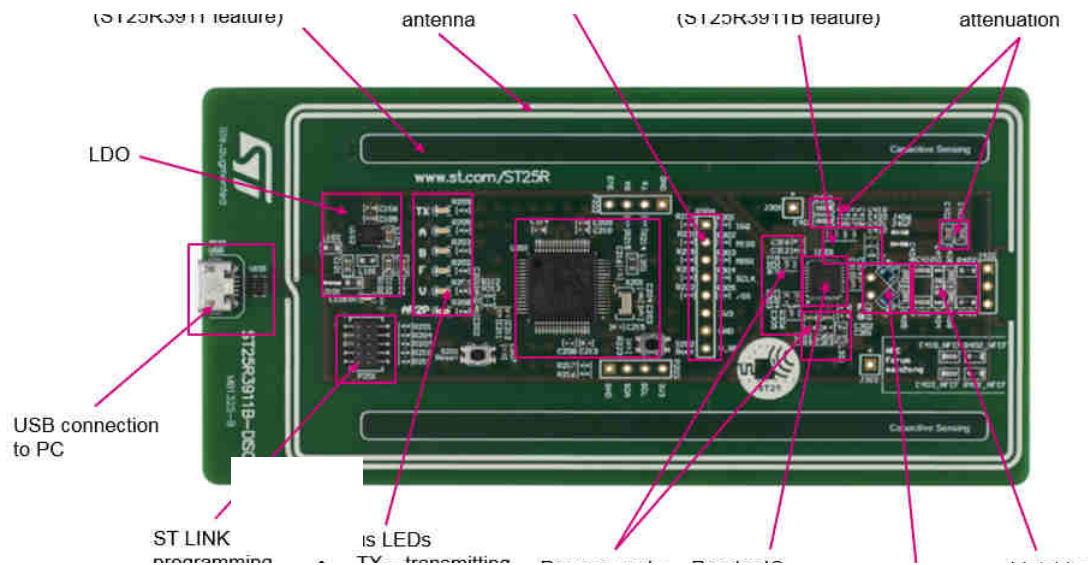
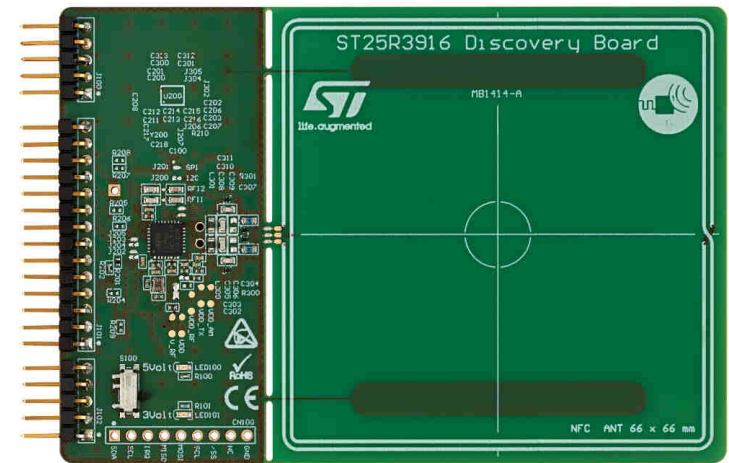
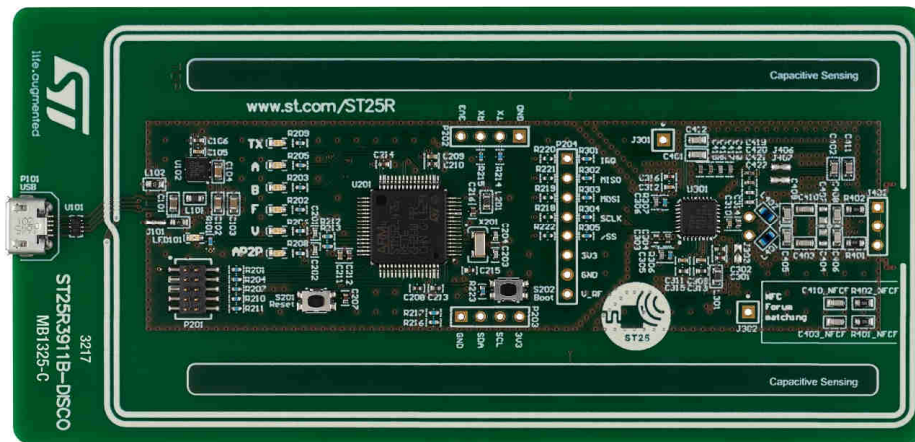
*ST25R3916 recommended for EMVCo 3.0 and above

- Antenna Design Matching tool
 - Calculates matching components
 - Includes simulation program
 - Available on ST25R3911B landing page



Design Tools

12

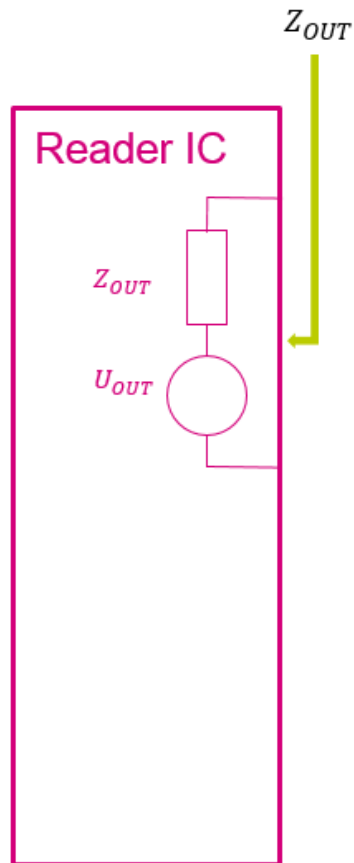




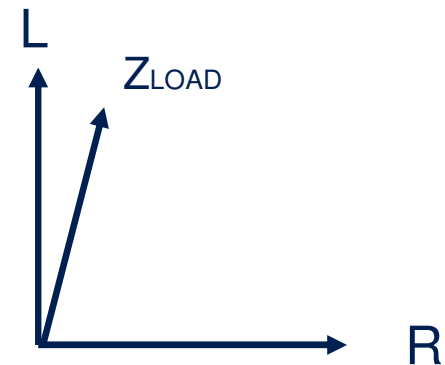
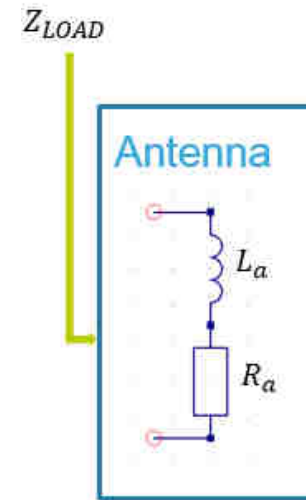
Matching Network

Matching Circuit

14

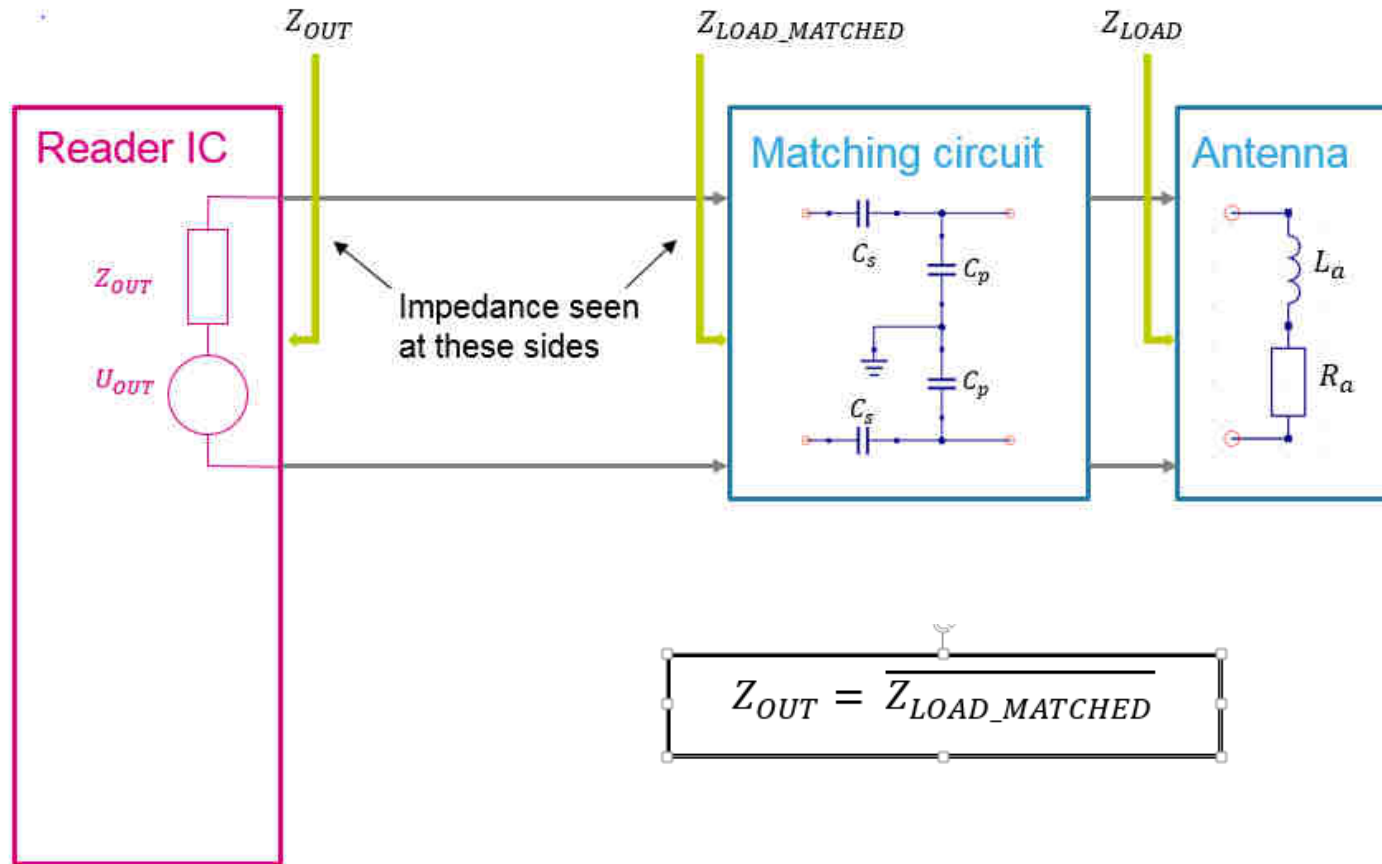


$$Z_{out} = \overline{Z_{LOAD}}$$



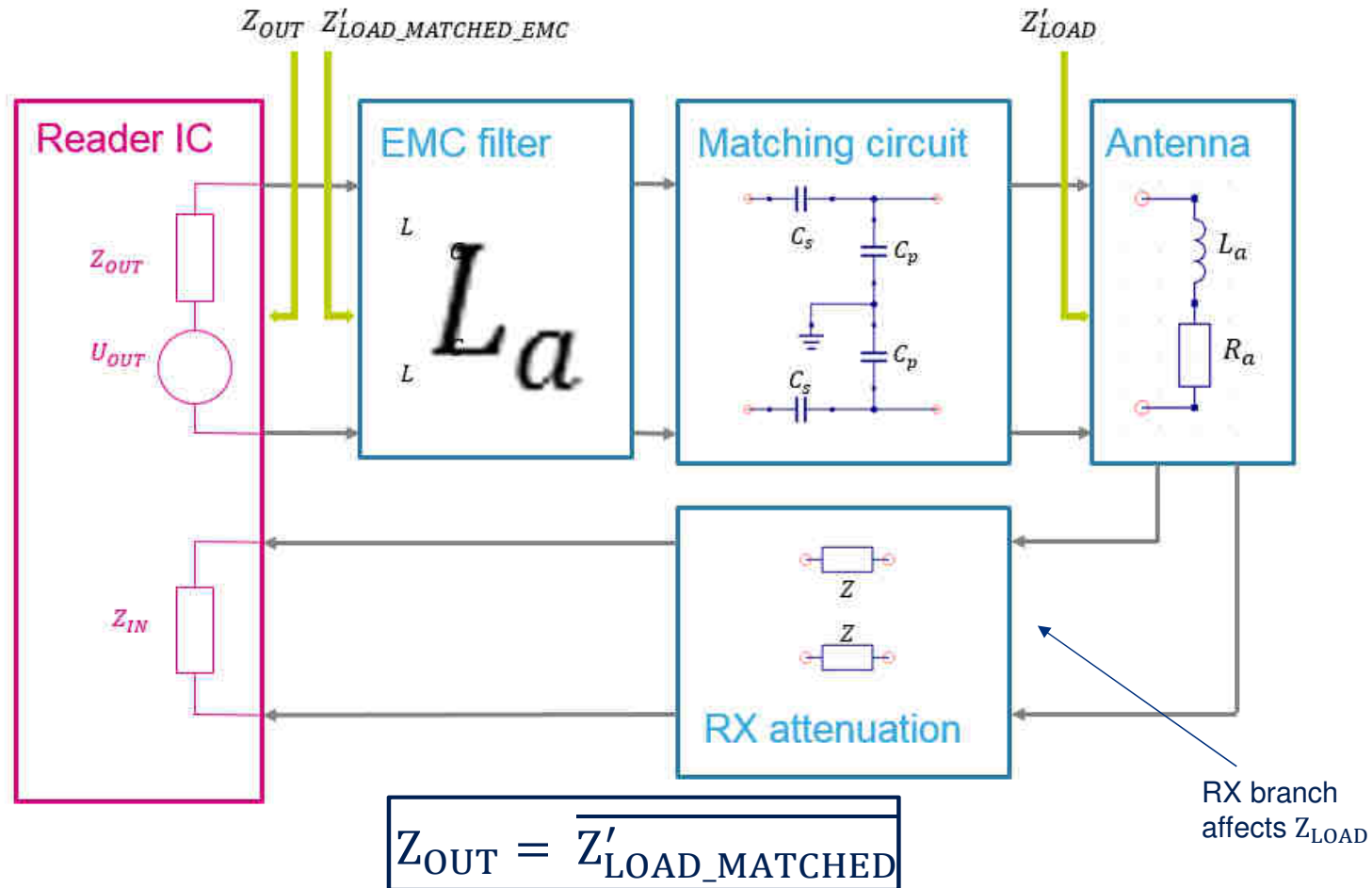
Matching Circuit

15



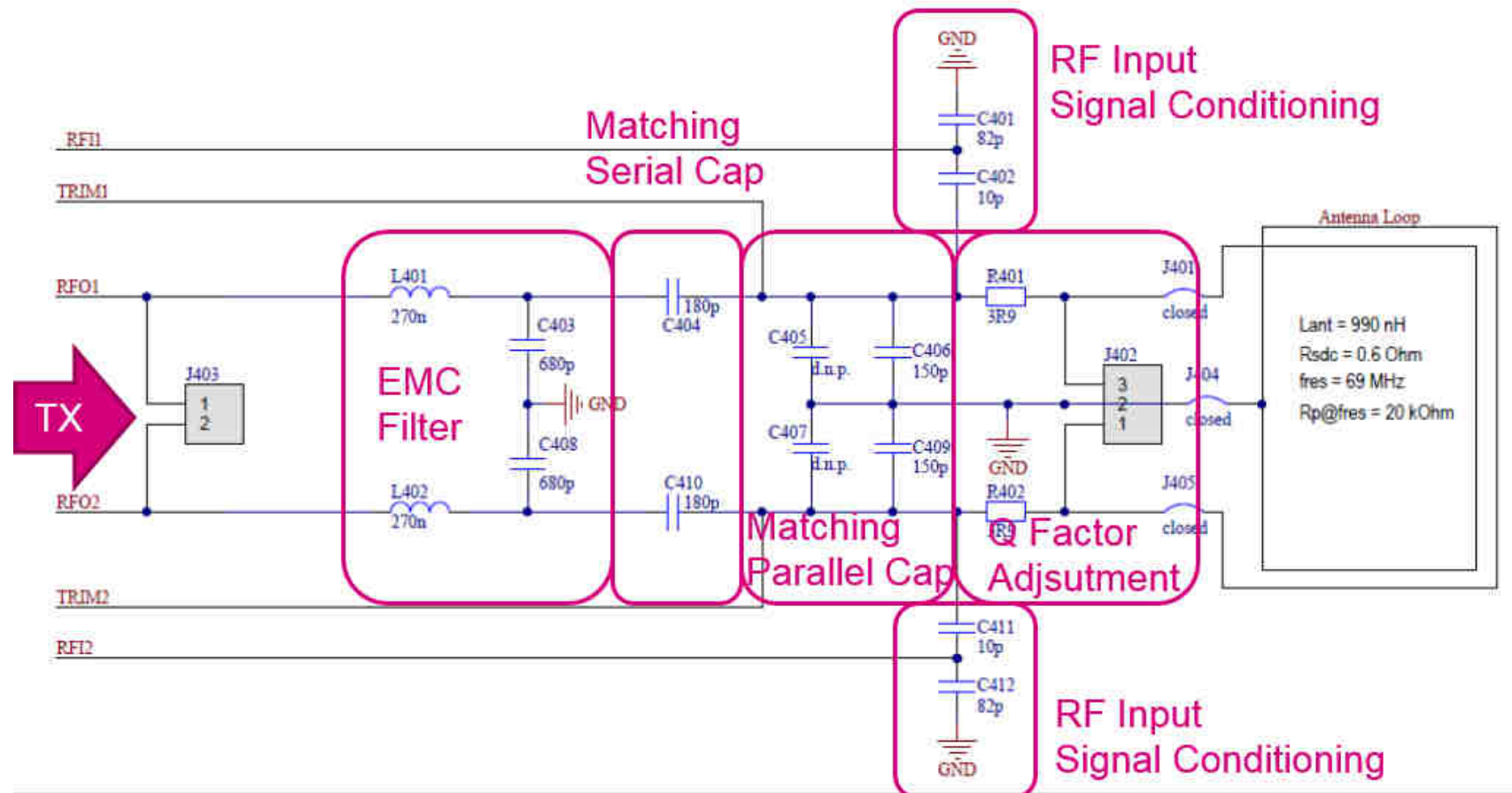
Matching Circuit

16



Matching Circuit

17



Matching Circuit

18

- Antenna
 - Two Turn
 - Typical Inductance 200nH – 2uH
- EMC Filter
 - Reduces harmonics of the RFO output stage
 - Target Cutoff Frequency about 13.56Mhz
- Matching Serial Cap
 - Impedance match from EMC filter to antenna resonator circuit
 - Cuts DC path from RFO1 to RFO2

Matching Circuit

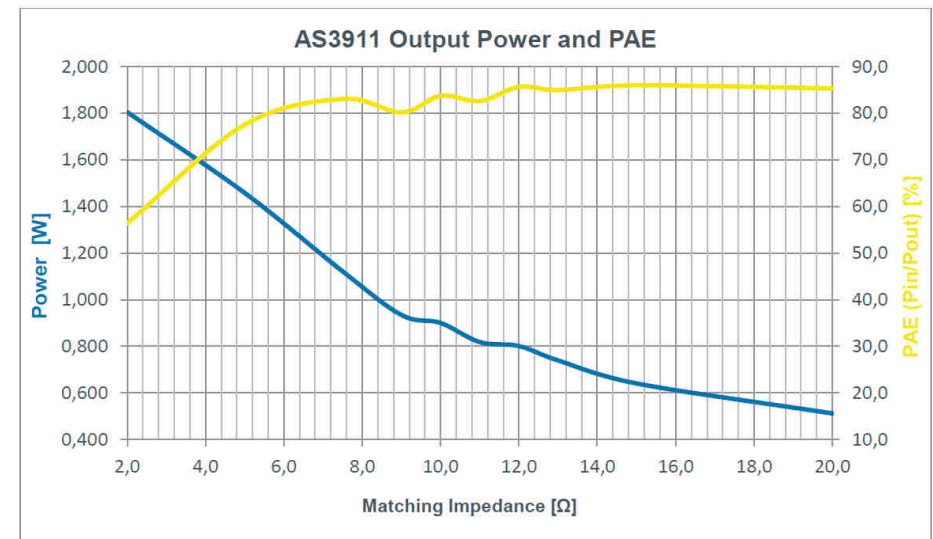
19

- Q Factor adjustment
 - Sets System Q (antenna Q should always be higher than System Q)
 - Higher Q > More Field Strength > Lower Datarate
 - Lower Q > Faster rise/fall times > Higher Datarate
 - Target Values
 - Up to 106kbps – 25
 - Up to 848kbps – 12-16
 - Up to 3.4Mbps - 8
- RFI Input Conditioning
 - Reduces Antenna Voltage to < 3.0Vpp for RFI input

Matching Circuit

20

- Target Matching impedance
 - Higher > less field strength > less power consumption > higher efficiency
 - Lower > higher field strength > higher power consumption > less efficiency
 - Range 8 – 120 ohms
 - Typically between 10 – 30 ohms



Antenna Parameters

21

Parameter	Action	Effect on parameter	Q factor
Q factor	Increase trace width	-	Increases
	Increase gap width		
Inductance	Larger antenna	Increases	Decreases
	Decrease trace width		
	Decrease gap width		
Series DC resistance	Larger antenna	Increases	Decreases
	Decrease trace width		
	Decrease gap width		
Parallel resistance	Decrease trace width	Increases	Increases
	Increase gap width		
Resonance frequency	Smaller antenna	Increases	Increases
	increase gap width		



Antenna Matching

Antenna Measurements

23

- Measure the following Parameters with a VNA

- DC resistance
- Inductance
- Self resonance frequency
- Parallel R @ F_{SR}

1:	1,000,000Hz
RL	-0.24dB
RP	164.79°
Z	6.7Ω
Rs	0.7Ω
Xs	6.7Ω
Swr	71.2:1
Mag	0.972
2:	13,563,694Hz
RL	-0.23dB
RP	55.51°
Z	95.0Ω
Rs	3.1Ω
Xs	94.9Ω
Swr	74.7:1
Mag	0.974
3:	53,729,443Hz
RL	-0.40dB
RP	0.08°
Z	2196.1Ω
Rs	2195.1Ω
Xs	65.1Ω
Swr	43.9:1
Mag	0.955

DC Resistance

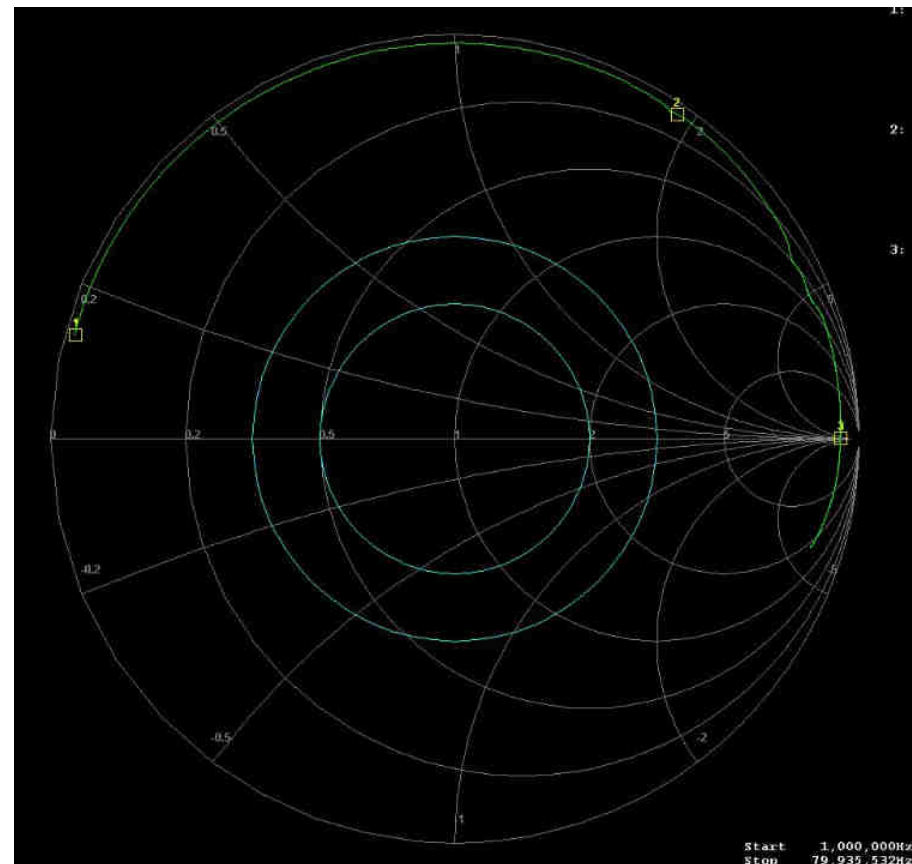
Xs @13.56MHz
used to
calculate
inductance

Self Resonant
Frequency

Parallel
Resistance

$$Xs = j\omega L$$

$$L = \frac{Xs}{j\omega}$$



Antenna Measurements

24

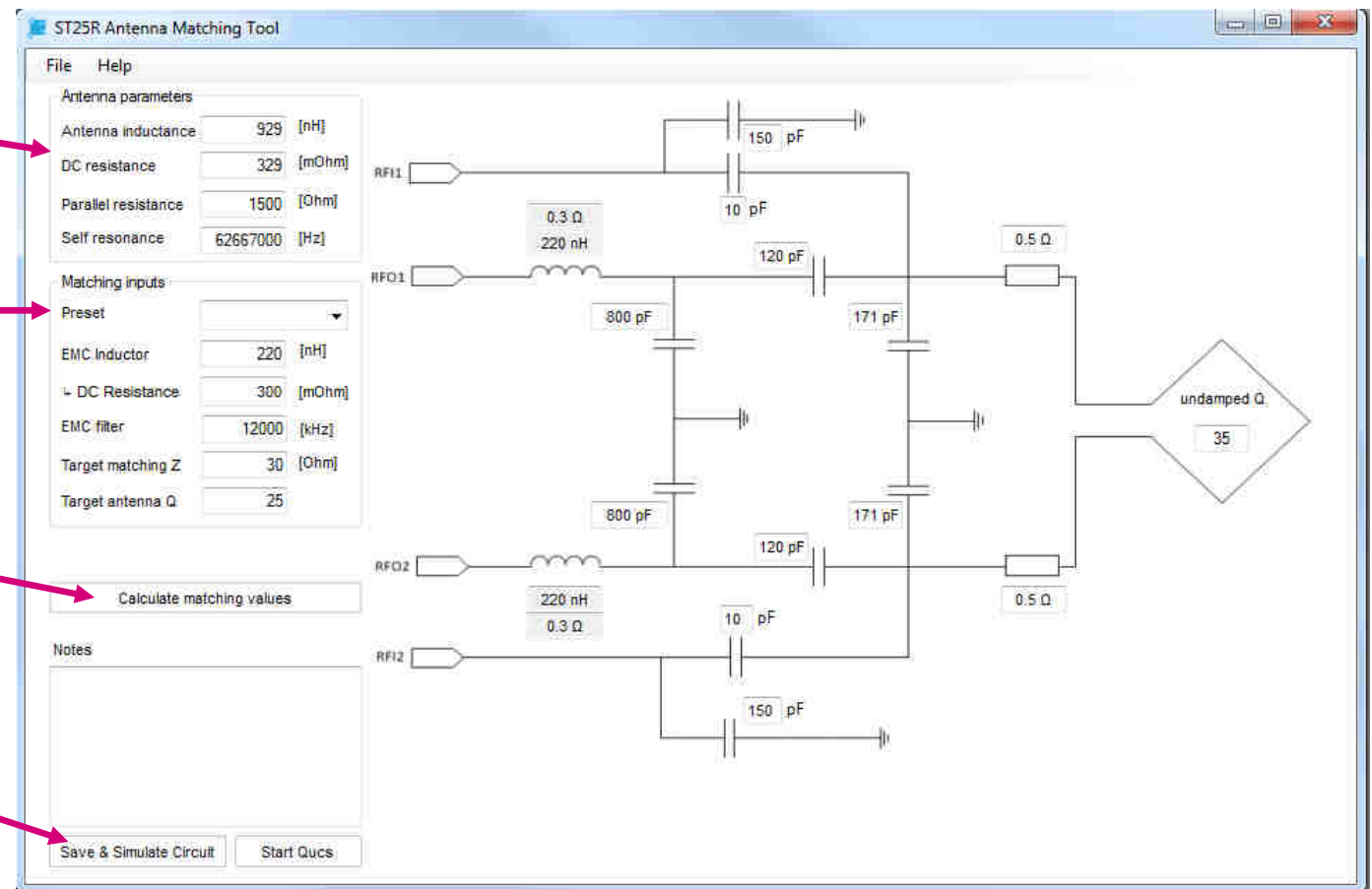
Input antenna parameters

Set pre-conditions

- EMVCo
- General Purpose
- VHBR

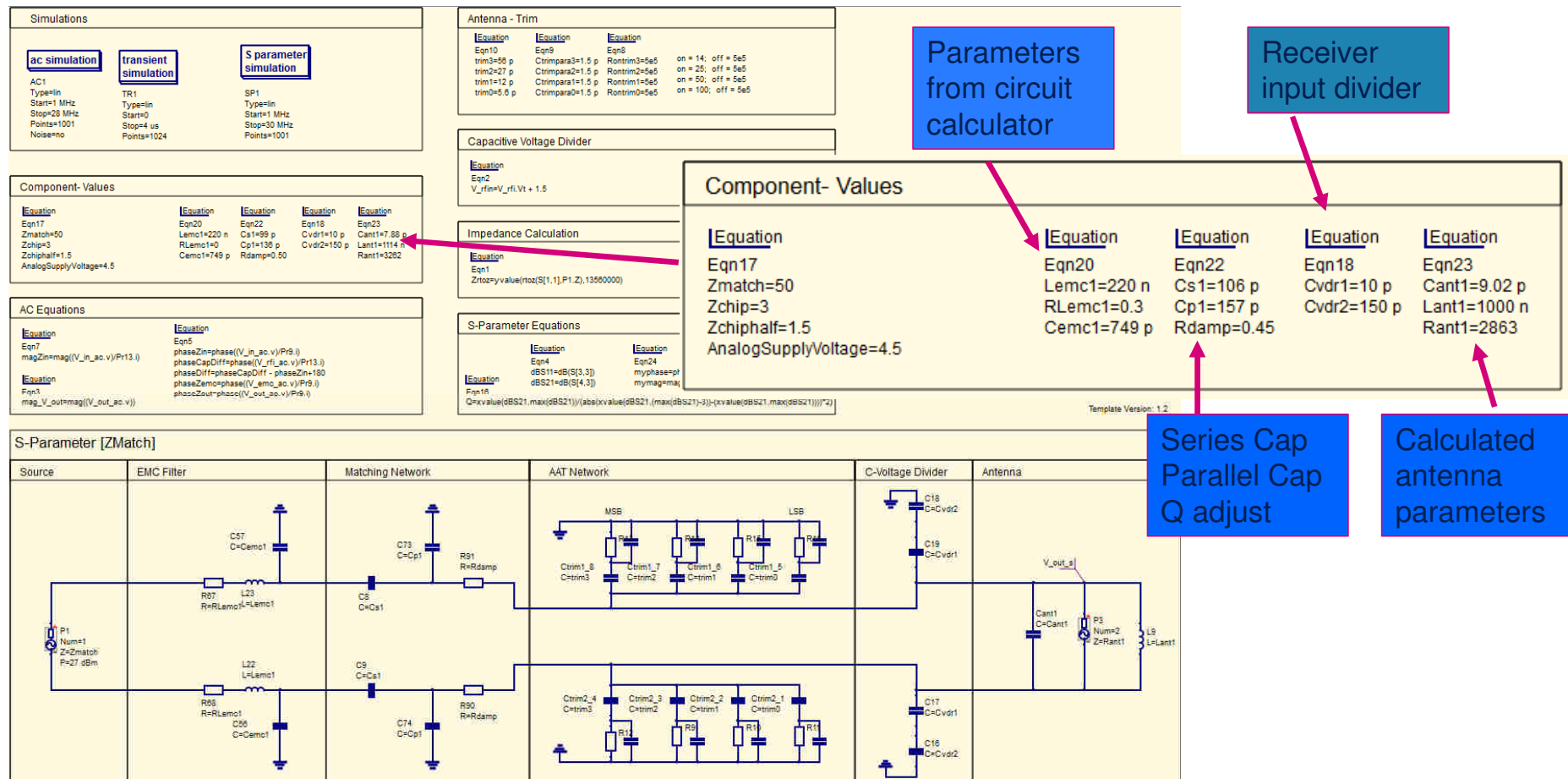
Calculate matching values

Simulate (opens QUCs)



Antenna Simulation

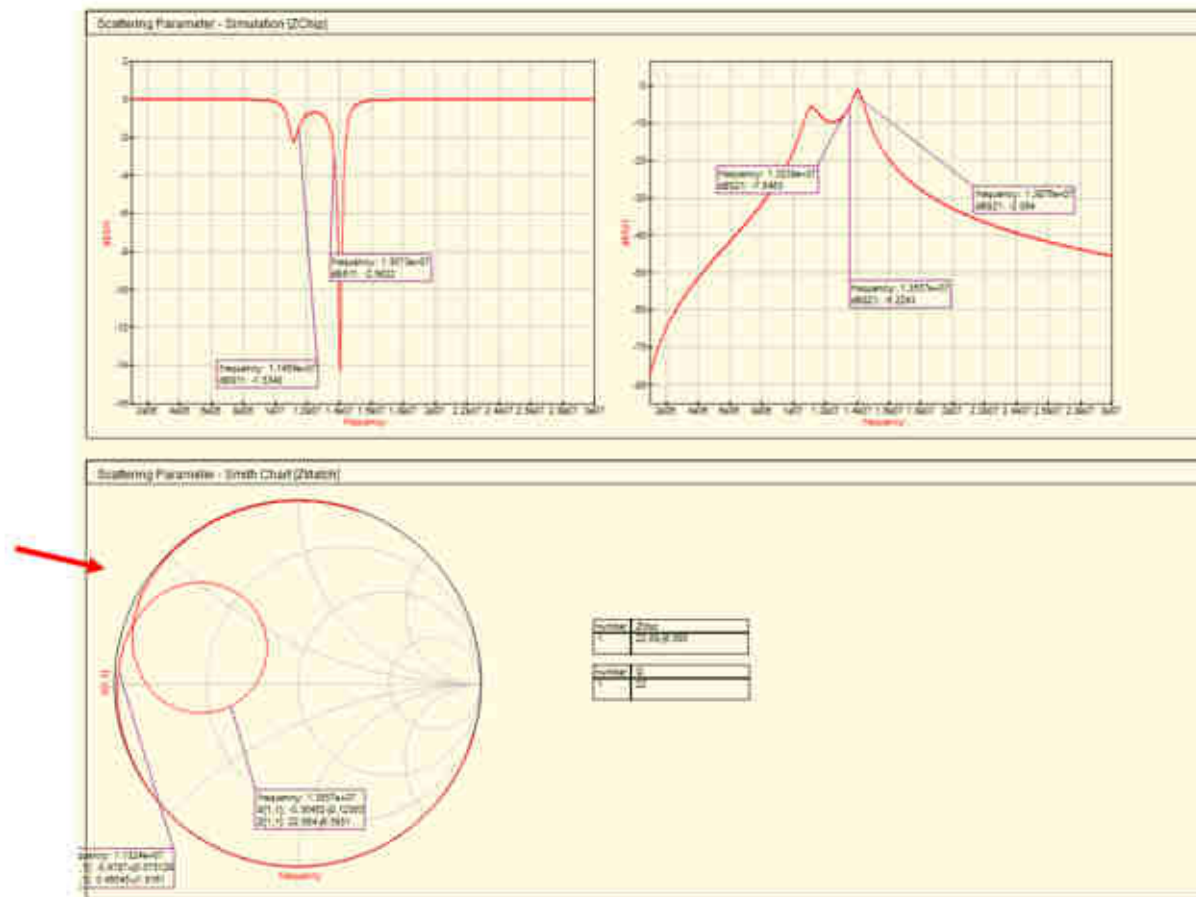
25



Antenna Simulation

26

Impedance
match info



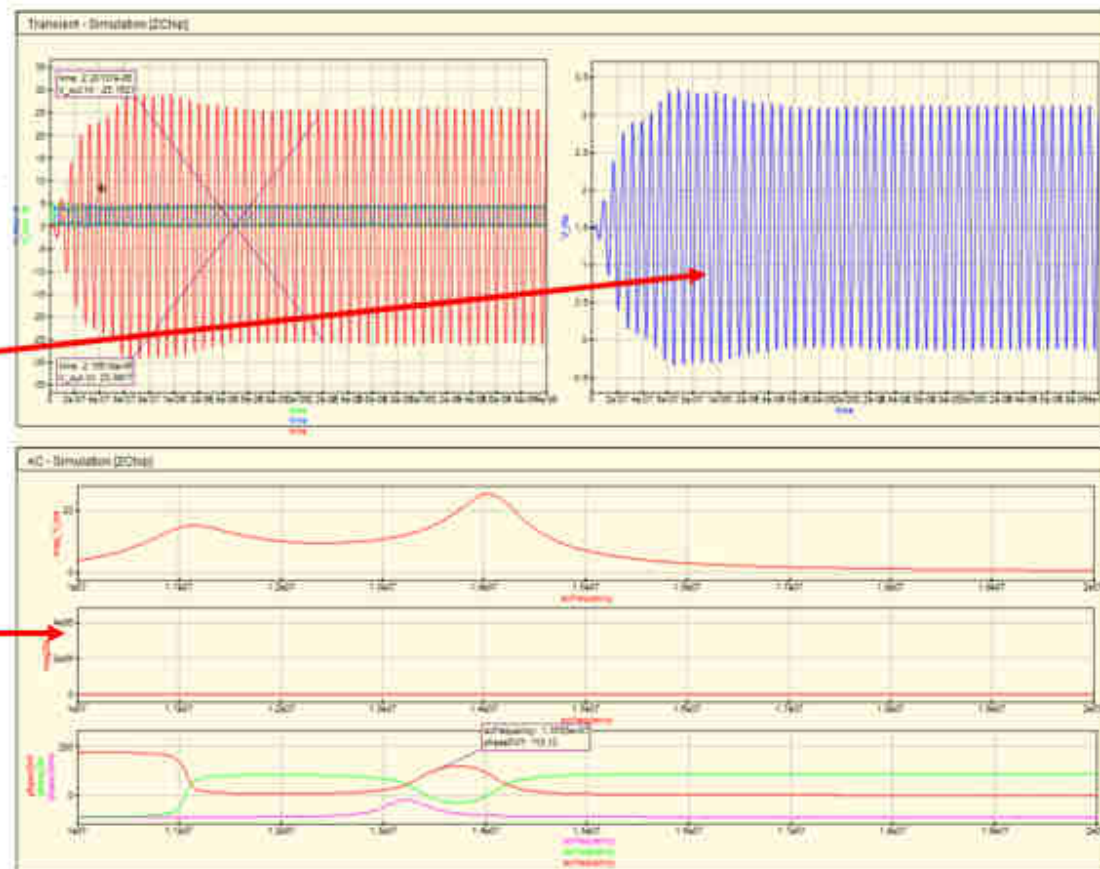
Antenna Simulation

27

Antenna
voltage

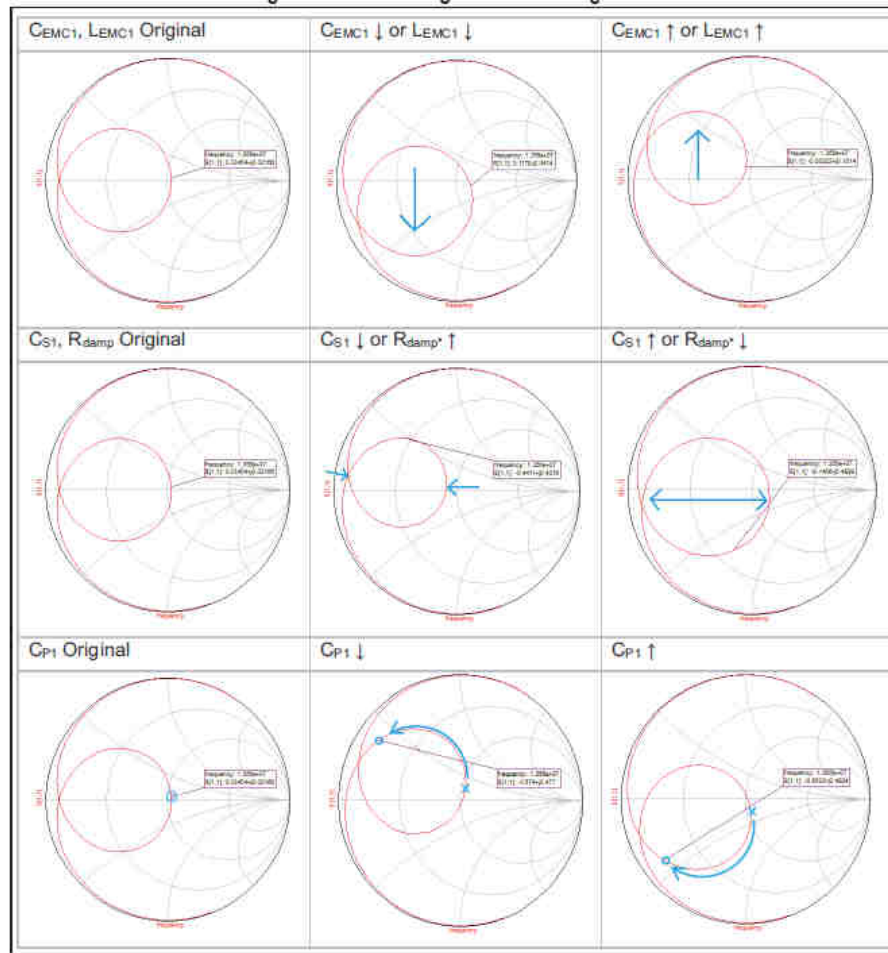
Receiver input

Phase and
Amplitude info



Fine Tuning

28



EMC
Components

- Serial Cap
- Damping Resistor

Parallel Cap

Next Steps

29

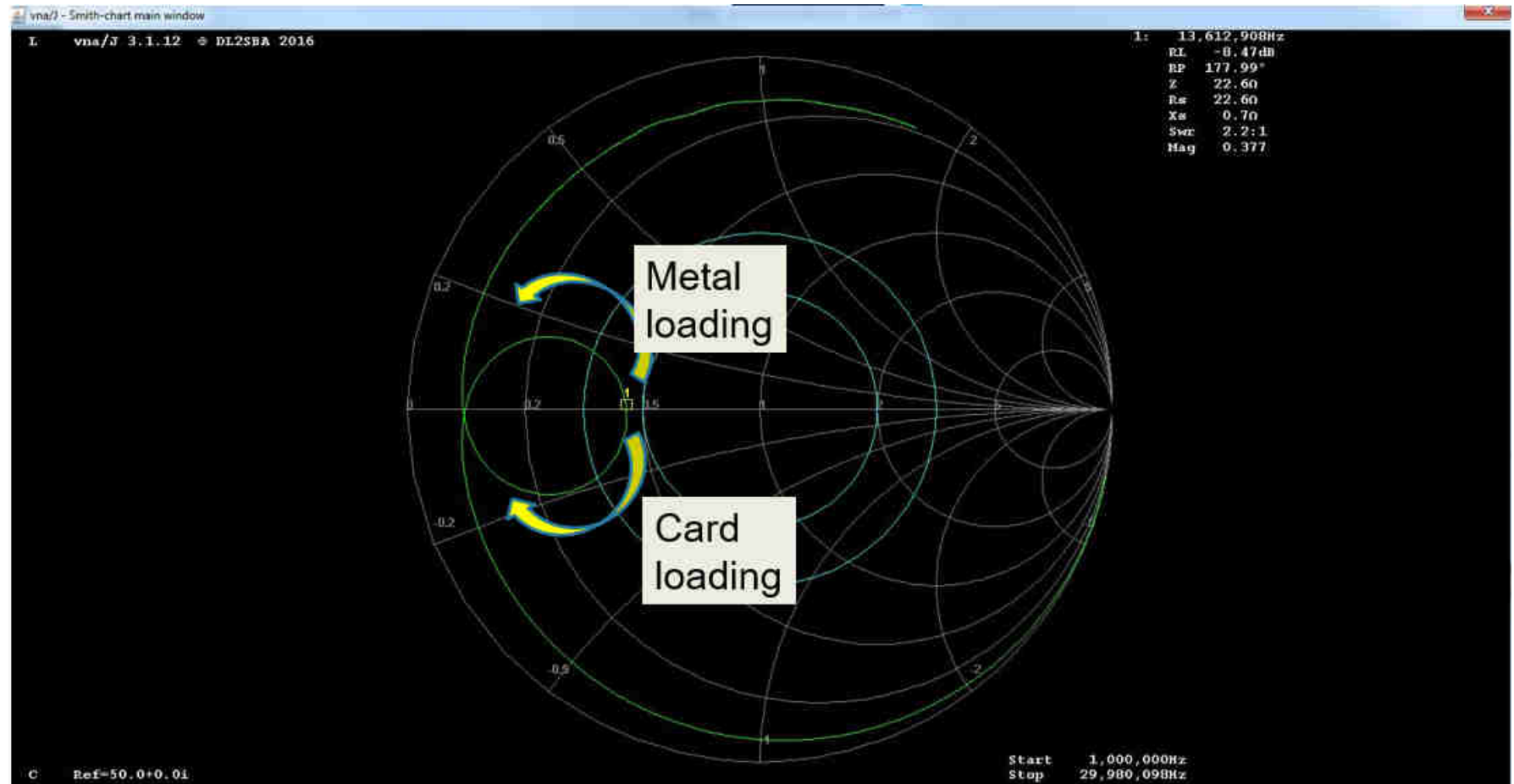
- Populate values on circuit board
- Measure match on RFO pins with VNA
- Re-adjust values as required
- Test
- Optimize read range vs current consumption

30

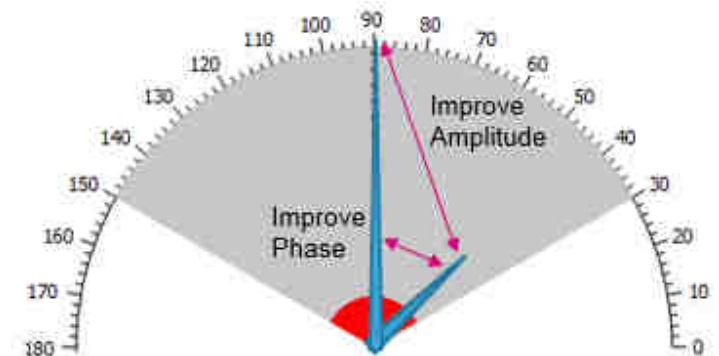


Antenna Loading

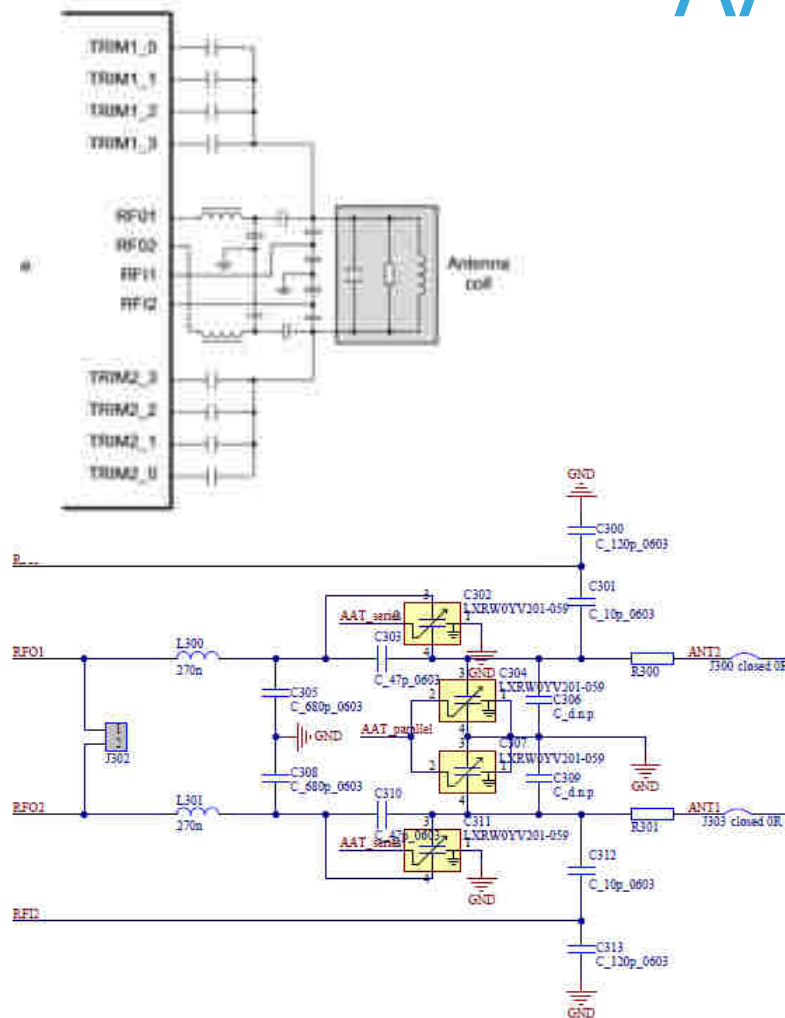
31



- Automatic Antenna Tuning
 - Allows the matching circuit to be adjusted on the fly
 - Adjustment range dependent on values used
 - Larger Values > Larger range > less granularity
 - Smaller Values > Smaller range > more granularity
 - Must be compensated for in the matching circuit



- ST25R3911B
 - 8 External Binary weighted capacitors (4 per RFO)
 - Switches internal to reader
- ST25R3916
 - Uses variable capacitors
 - Internal DAC's use to control variable capacitors
 - Can be used to control both Serial and Parallel Caps



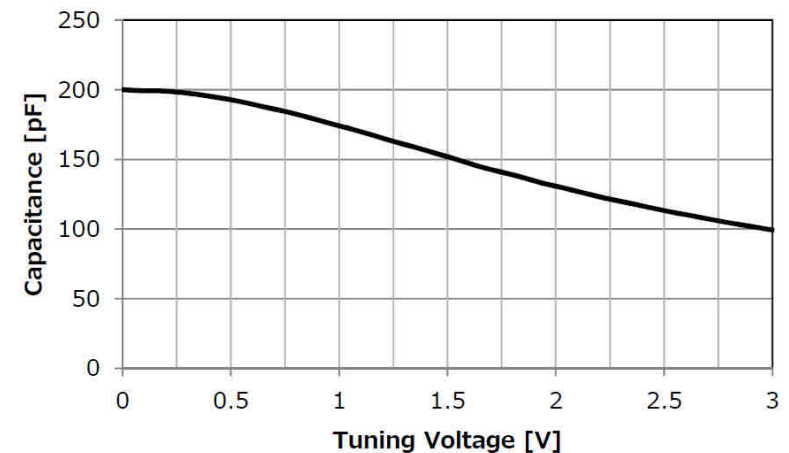
AAT Compensation

34

- Match antenna as before
- Determine serial/parallel capacitors
- ST25R3916
 - Subtract $\frac{3}{4}$ Variable cap value from C_p
 - This becomes new parallel capacitor
- ST25R3911B
 - Subtract Highest trim value cap from C_p
 - This becomes new parallel capacitor



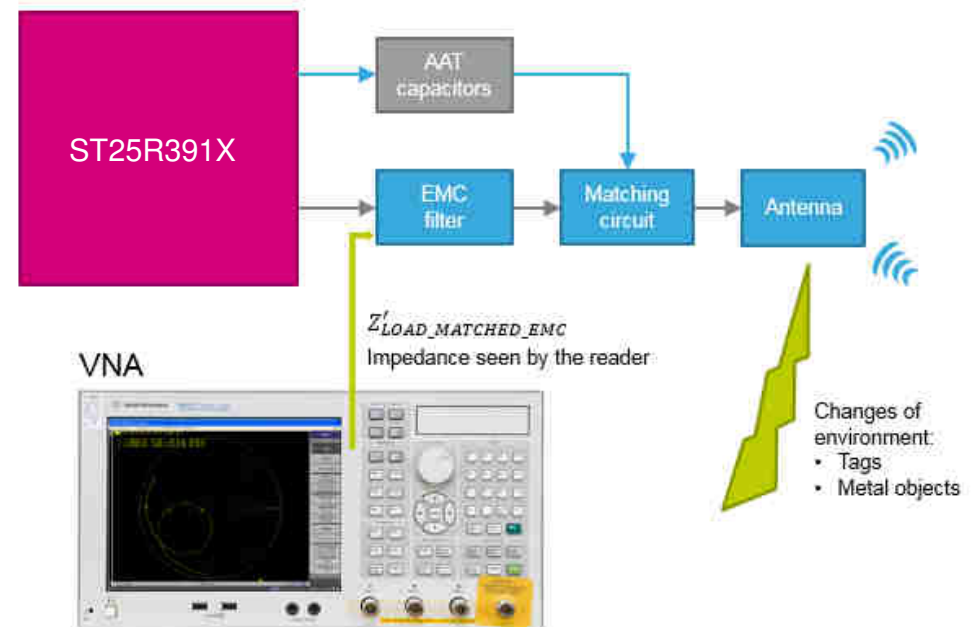
Capacitance characteristics (Typical)



- ST25R3911B
 - Set reg 27 to 0xff (double check that no field is being generated)
 - Adjust AAT trim to 8 (Antenna Tab in GUI)
 - Match should be in center of range
- ST25R3916
 - Set reg 28 to 0x7f (double check that no field is being generated)
 - Adjust AAT trim mid (Antenna Tab in GUI)
 - Match should be in center of range

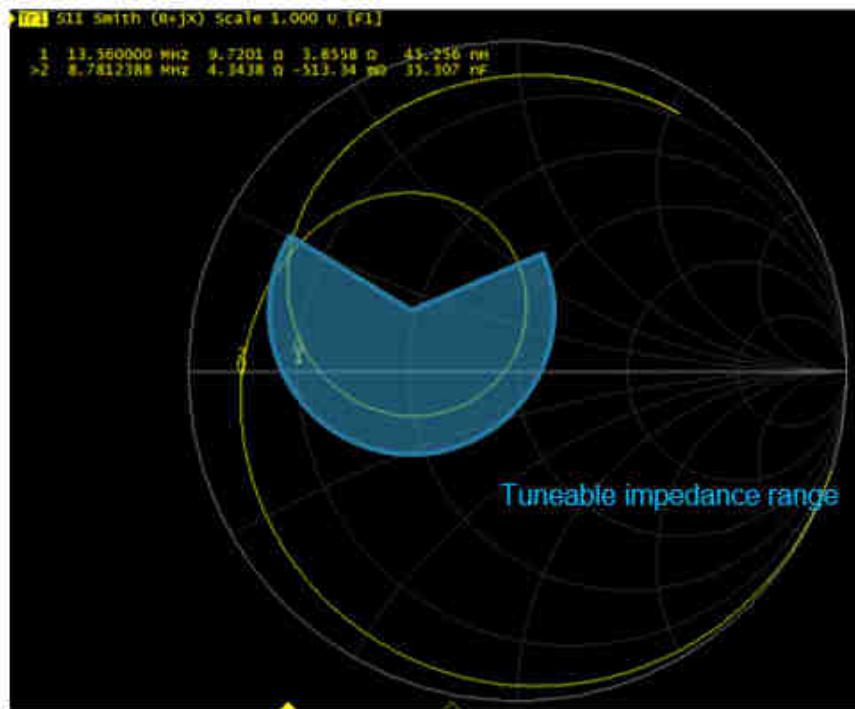
Important to turn off output drivers

- Measurement of how AAT changes the impedance of the antenna seen by the reader

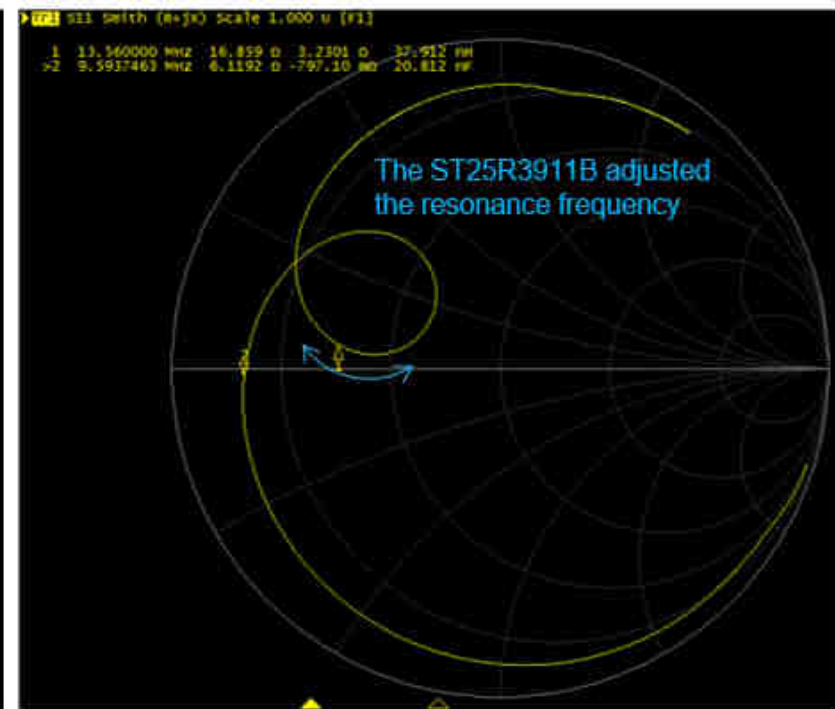


AAT Range

36



ST25R3916



ST25R3911B

AAT Simulation 37

Simulations

ac simulation
 AC1
 Type=lin
 Start=1 MHz
 Stop=28 MHz
 Points=1001
 Noise=0

transient simulation
 TR1
 Type=lin
 Start=0
 Stop=4 us
 Points=1024

S parameter simulation
 SP1
 Type=lin
 Start=1 MHz
 Stop=30 MHz
 Points=1001

Antenna - Trim

Equation	Equation	Equation
Eqn10 trim3=56 p	Eqn9 Ctrimpara3=1.5 p	Eqn8 Rontrim3=5e5
trim2=27 p	Ctrimpara2=1.5 p	on = 14; off = 5e5
trim1=12 p	Ctrimpara1=1.5 p	on = 25; off = 5e5
trim0=5.6 p	Ctrimpara0=1.5 p	on = 50; off = 5e5
		on = 100; off = 5e5

Capacitive Voltage Divider

Equation
Eqn2
 $V_{rf} = V_{rf} \cdot V_t + 1.5$

Impedance Calculation

Equation
Eqn1
 $Z_{in} = \text{value}(\text{toz}(S(1,1), P1, Z), 13500000)$

S-Parameter Equations

Equation	Equation
Eqn4 dBS11=dB(S(3,3))	Eqn24 myphase=phaseDiff
Eqn18 Cvxvalue(dBS21,max(dBS21))/(abs(xvalue(dBS21,3))-xvalue(dBS21,max(dBS21))))*(2)	

Antenna - Trim

Equation	Equation	Equation
Eqn10 trim3=56 p	Eqn9 Ctrimpara3=1.5 p	Eqn8 Rontrim3=5e5
trim2=27 p	Ctrimpara2=1.5 p	on = 14; off = 5e5
trim1=12 p	Ctrimpara1=1.5 p	on = 25; off = 5e5
trim0=5.6 p	Ctrimpara0=1.5 p	on = 50; off = 5e5
		on = 100; off = 5e5

AC Equations

Equation
Eqn7
 $\text{magZin} = \text{mag}(V_{in_ac_v}) / P(13.0)$

Equation
Eqn3
 $\text{magV_out} = \text{mag}(V_{out_ac_v})$

Equation
Eqn5
 $\text{phaseZin} = \text{phase}(V_{in_ac_v}) / P(9.0)$

Equation
Eqn6
 $\text{phaseCapDiff} = \text{phase}(V_{rf_ac_v}) / P(13.0)$

Equation
Eqn18
 $\text{phaseZin} = \text{phase}(V_{in_ac_v}) / P(9.0)$

Equation
Eqn19
 $\text{phaseZin} = \text{phase}(V_{in_ac_v}) / P(9.0)$

S-Parameter [ZMatch]

Source	EMC Filter	Match

Layout Suggestions

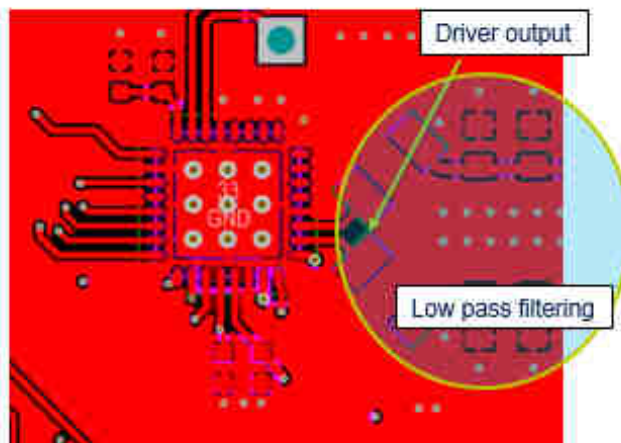
38

- 4 layer board if possible (Sig/GND/PWR/Sig)
- Make RFO paths symmetrical
- Keep traces short
- EMC filter as close as possible to RFO pins
- Layout extra pads for Cs and Cp for fine tuning
- Layout pads for AAT (just in case)

Layout Suggestions

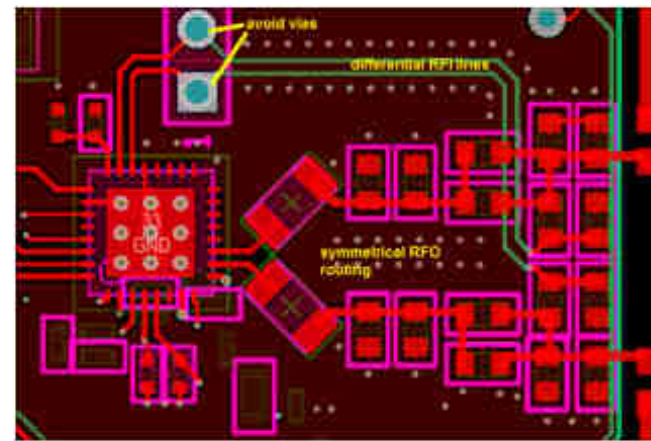
39

EMC filter



- Filter must be positioned as close as possible to the output stages

RFO & RFI routing

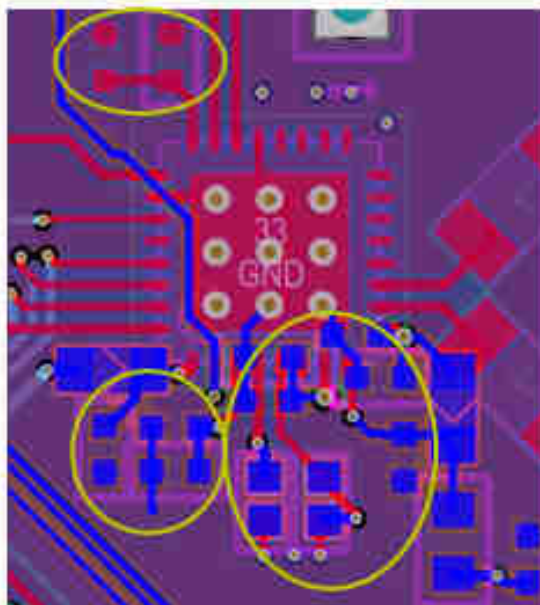


- The inductors after the RFO are placed in 90 degree direction
- The RFI lines are routed symmetrically, but in a fair distance to the RFO lines
- No long signal traces between LC filter and the remaining matching components
- The vias in the RFI lines should be avoided in a final design

Layout Suggestions

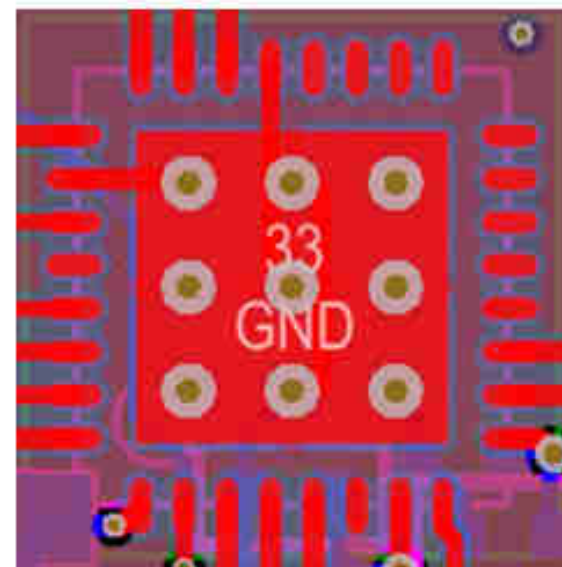
40

Decoupling



- Capacitors as close as possible to the chip
- Parallel capacitors 2.2 μ F and 10 nF

Thermal pad



- Ground plane & thermal heatsink
- Multiple through vias must be used

Questions?

41